



ENG-E23-005 - Distributors

JAE Electronics, Inc.
January 9th, 2023

PCN (Process Change Notice) MX34R05HF4T Replacement Mold Die To Keep Production Capacity

Part Number	1 Existing Mold Die with 2 cavities	1 Replacement Mold Die created with 4 cavities	Replacement Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX34R05HF4T	(A,B)	(C,D,E,F) To replace (A,B)	June 2023	September 2023	December 2023

Notes:

- PC = Process Change (Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process
 1. PC PPAP will only be prepared and provided to customer who already received and provided initial PPAP approval.
 2. If you request PPAP documents for this notification, please notify us ASAP.